

RELIABILITY REPORT

FOR

MAX6372KA+

PLASTIC ENCAPSULATED DEVICES

July 14, 2009

MAXIM INTEGRATED PRODUCTS

120 SAN GABRIEL DR. SUNNYVALE, CA 94086

Approved by	
Ken Wendel	
Quality Assurance	
Director, Reliability Engineering	



Conclusion

The MAX6372KA+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim"s continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim"s quality and reliability standards.

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I. Device Description

A. General

The MAX6369-MAX6374 are pin-selectable watchdog timers that supervise microprocessor (μ P) activity and signal when a system is operating improperly. During normal operation, the microprocessor should repeatedly toggle the watchdog input (WDI) before the selected watchdog timeout period elapses to demonstrate that the system is processing code properly. If the μ P does not provide a valid watchdog input transition before the timeout period expires, the supervisor asserts a watchdog (active-low WDO) output to signal that the system is not executing the desired instructions within the expected time frame. The watchdog output pulse can be used to reset the μ P or interrupt the system to warn of processing errors. The MAX6369-MAX6374 are flexible watchdog timer supervisors that can increase system reliability through notification of code execution errors. The family offers several pin-selectable watchdog timing options to match a wide range of system timing applications: - Watchdog startup delay: provides an initial delay before the watchdog timer is started. - Watchdog timeout period: normal operating watchdog timeout period after the initial startup delay. - Watchdog output/timing options: open drain (100ms) or push-pull (1ms). The MAX6369-MAX6374 operate over a +2.5V to +5.5V supply range and are available in miniature 8-pin SOT23 packages.



II. Manufacturing Information

A. Description/Function: Pin-Selectable Watchdog Timers

B. Process: B8

C. Number of Device Transistors:

D. Fabrication Location: Oregon
E. Assembly Location: Thailand
F. Date of Initial Production: April 22, 2000

III. Packaging Information

A. Package Type: 8-pin SOT23
B. Lead Frame: Copper Alloy
C. Lead Finish: 100% matte Tin

D. Die Attach: Non Conductive Epoxy
E. Bondwire: Au (1.0 mil dia.)
F. Mold Material: Epoxy with silica filler

G. Assembly Diagram: #

H. Flammability Rating: Class UL94-V0

I. Classification of Moisture Sensitivity per Level 1

JEDEC standard J-STD-020-C

J. Single Layer Theta Jb: 112*°C/WK. Single Layer Theta Jc: 80°C/W

IV. Die Information

A. Dimensions: 55 X 31 mils

B. Passivation: Si₃N₄/SiO₂ (Silicon nitride/ Silicon dioxide

C. Interconnect: Al/0.5%CuD. Backside Metallization: None

E. Minimum Metal Width: 0.8 microns (as drawn)F. Minimum Metal Spacing: 0.8 microns (as drawn)

G. Bondpad Dimensions: 5 mil. Sq.
 H. Isolation Dielectric: SiO₂
 I. Die Separation Method: Wafer Saw



V. Quality Assurance Information

A. Quality Assurance Contacts: Ken Wendel (Director, Reliability Engineering)

Bryan Preeshl (Managing Director of QA)

B. Outgoing Inspection Level: 0.1% for all electrical parameters guaranteed by the Datasheet.

0.1% For all Visual Defects.

C. Observed Outgoing Defect Rate: < 50 ppmD. Sampling Plan: Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 135°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

$$\lambda = 1 \over \text{MTTF}$$
 = 1.83 (Chi square value for MTTF upper limit)
192 x 4340 x 80 x 2 (where 4340 = Temperature Acceleration factor assuming an activation energy of 0.8eV)

$$\lambda = 13.4 \times 10^{-9}$$

 $\lambda = 13.4 \text{ F.I.T. (60\% confidence level @ 25°C)}$

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly 1000 hour life test monitors on its processes. This data is published in the Product Reliability Report found at http://www.maxim-ic.com/. Current monitor data for the B8 Process results in a FIT Rate of 1.29 @ 25C and 15.6 @ 55C (0.8 eV, 60% UCL)

B. Moisture Resistance Tests

The industry standard $85^{\circ}\text{C}/85\%\text{RH}$ or HAST testing is monitored per device process once a quarter.

C. E.S.D. and Latch-Up Testing

The MS37-3 die type has been found to have all pins able to withstand a HBM transient pulse of +/-1500 V per Mil-Std 883 Method 3015.7. Latch-Up testing has shown that this device withstands a current of +/-250 mA.



Table 1Reliability Evaluation Test Results

MAX6372KA+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	
Static Life Test (Note 1)				
·	Ta = 135°C Biased Time = 192 hrs.	DC Parameters & functionality	80	0	
Moisture Testing 85/85	(Note 2) Ta = 85°C RH = 85%	DC Parameters & functionality	77	0	
	Biased Time = 1000hrs.				
Mechanical Stress	s (Note 2)				
Temperature	-65°C/150°C	DC Parameters	77	0	
Cycle	1000 Cycles Method 1010	& functionality			

Note 1: Life Test Data may represent plastic DIP qualification lots.

Note 2: Generic Package/Process data